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# FDB0300N1007L N-Channel PowerTrench<sup>®</sup> MOSFET 100 V, 200 A, 3 m $\Omega$

## Features

- Max  $r_{DS(on)}$  = 3 m $\Omega$  at  $V_{GS}$  = 10 V,  $I_D$  = 26 A
- Max  $r_{DS(on)}$  = 4.5 m $\Omega$  at V<sub>GS</sub> = 6 V, I<sub>D</sub> = 20 A
- Fast Switching Speed
- Low Gate Charge
- $\blacksquare$  High Performance Trench Technology for Extremely Low  $R_{DS(on)}$
- High Power and Current Handling Capability
- RoHS Compliant



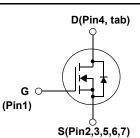
# **General Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor's advance PowerTrench<sup>®</sup> process that has been especially tailored to minimize the on-state resistance while maintaining superior ruggedness and switching performance for industrial applications.

## Applications

- Industrial Motor Drive
- Industrial Power Supply
- Industrial Automation
- Battery Operated tools
- Battery Protection
- Solar Inverters
- UPS and Energy Inverters
- Energy Storage
- Load Switch





**MOSFET Maximum Ratings** T<sub>C</sub> = 25 °C unless otherwise noted.

Symbol	Parameter       Drain to Source Voltage			Ratings	Units V	
V <sub>DS</sub>				100		
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous	T <sub>C</sub> = 25°C	(Note 5)	200		
	-Continuous	T <sub>C</sub> = 100°C	(Note 5)	140	Α	
	-Pulsed		(Note 4)	1090		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	843	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25°C		250		
	Power Dissipation	T <sub>A</sub> = 25°C	(Note 1a)	3.8		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +175	°C	

#### Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	(Note 1)	0.6	°C AA
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	40	°C/W

### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDB0300N1007L	FDB0300N1007L	D2-PAK-7L	330 mm	24 mm	800 units

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units	
Off Chara	octeristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	100			V	
$\frac{\Delta BV_{DSS}}{\Delta T_{.1}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		57		mV/°C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V			1	μA	
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA	
On Chara	cteristics (Note 2)						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA	2	2.7	4	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-12		mV/°C	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 26 A		2.4	3		
		V <sub>GS</sub> = 6 V, I <sub>D</sub> = 20 A		3.4	4.5	mΩ	
		$V_{GS}$ = 10 V, I <sub>D</sub> = 26 A, T <sub>J</sub> = 150°C		4.9	11		
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 26 A		85		S	
-	Characteristics				1	1	
C <sub>iss</sub>	Input Capacitance	– V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V,		5925	8295	pF	
C <sub>oss</sub>	Output Capacitance	f = 1 MHz		1220	1710	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance			42	60	pF	
R <sub>g</sub>	Gate Resistance			2.7		Ω	
Switching	g Characteristics						
t <sub>d(on)</sub>	Turn-On Delay Time			28	45	ns	
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 50 V, I <sub>D</sub> = 26 A,		29	46	ns	
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>GS</sub> = 10 V, R <sub>GEN</sub> = 6 Ω		52	83	ns	
t <sub>f</sub>	Fall Time			18	32	ns	
Qg	Total Gate Charge	$V_{GS}$ = 0 V to 10 V		81	113	nC	
Qg	Total Gate Charge	$V_{GS}$ = 0 V to 5 V $V_{DD}$ = 50 V,		44	62		
Q <sub>gs</sub>	Gate to Source Gate Charge	I <sub>D</sub> = 26 A		24		nC	
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			16		nC	
Drain-Sou	urce Diode Characteristics						
I <sub>S</sub>	Maximum Continuous Drain to Source Diode Forward Current				200	Α	
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current				1090	Α	
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 26 A$ (Note 2)		0.8	1.2	V	
	Reverse Recovery Time	$-I_{\rm F} = 26$ A, di/dt = 100 A/µs		84	134	ns	
t <sub>rr</sub>	5						

1. R<sub>0,L</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>0,L</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.

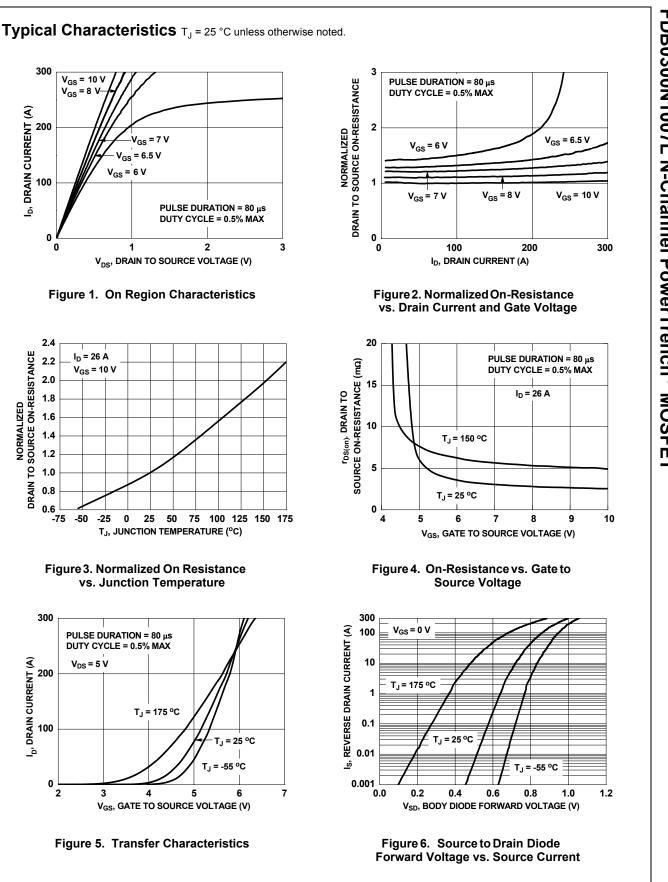
a) 40 °C/W when mounted on a 1 in² pad of 2 oz copper. b) 62.5 °C/W when mounted on a minimum pad of 2 oz copper.

2. Pulse Test: Pulse Width < 300  $\mu s,$  Duty cycle < 2.0 %.

3.  $E_{AS}$  of 843 mJ is based on starting  $T_J$  = 25 °C, L = 0.3 mH,  $I_{AS}$  = 75 A,  $V_{DD}$  = 90 V,  $V_{GS}$  = 10 V. 100% test at L = 0.1 mH,  $I_{AS}$  = 108 A.

4. Pulsed Id please refer to Figure "Forward Bias Safe Operating Area" for more details.

5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.



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300

200

100

0

2.4

2.2

2.0

1.8

1.6

1.4

1.2

1.0 0.8

0.6

300

200

100

0

2

I<sub>D</sub>, DRAIN CURRENT (A)

PULSE DURATION = 80 µs DUTY CYCLE = 0.5% MAX

T<sub>J</sub> = 175 °C

4

 $V_{DS} = 5 V$ 

3

-75 -50 -25 0 25 50

I<sub>D</sub> = 26 A

V<sub>GS</sub> = 10 V

DRAIN TO SOURCE ON-RESISTANCE

NORMALIZED

0

I<sub>D</sub>, DRAIN CURRENT (A)

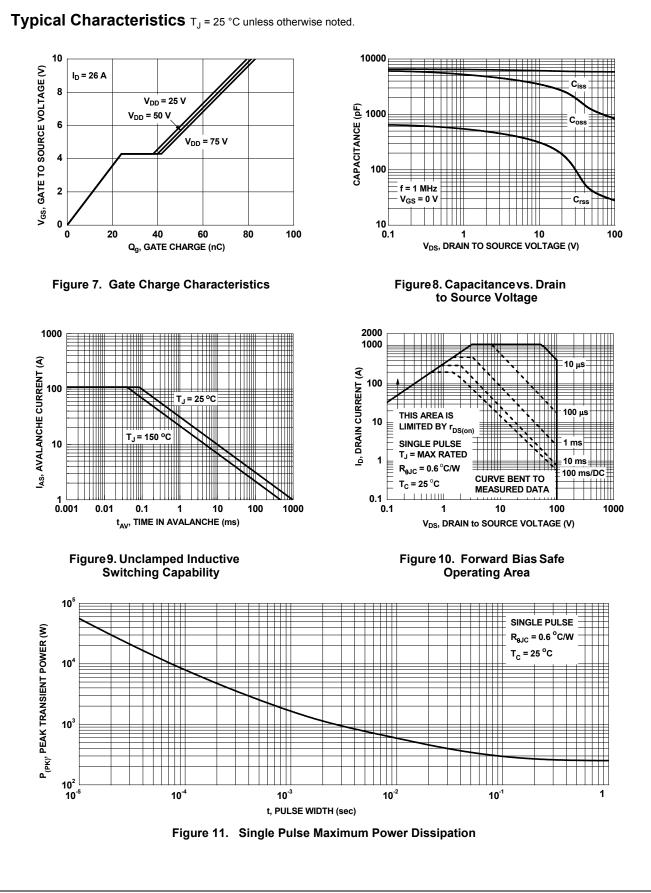
V<sub>GS</sub> = 10 V

V<sub>GS</sub> = 7 V

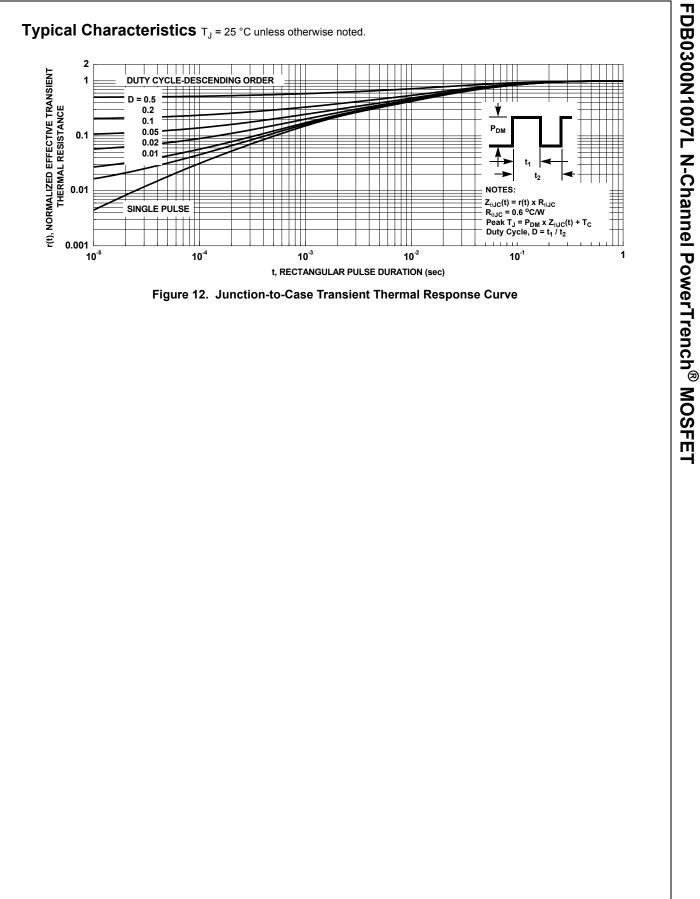
= 6.5 V V<sub>GS</sub> V<sub>GS</sub> = 6 V

1

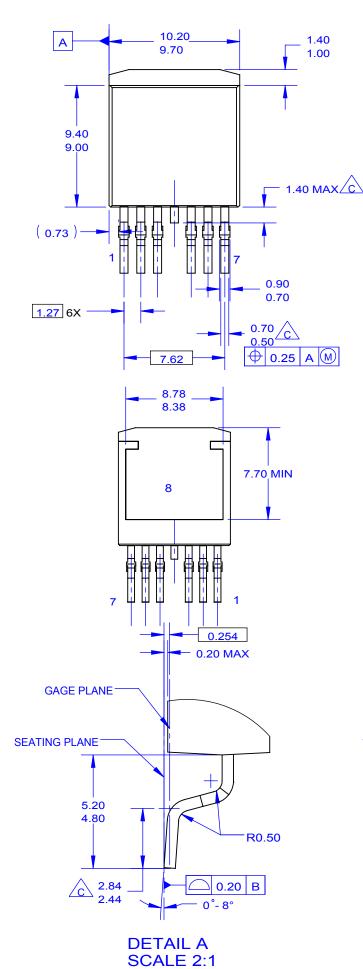
V<sub>GS</sub> = 8

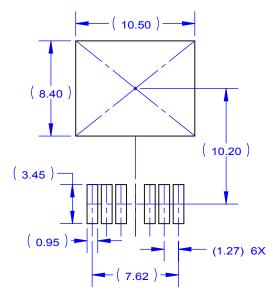


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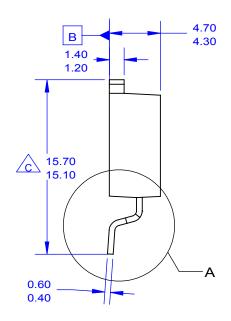


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#### LAND PATTERN RECOMMENDATION



#### NOTES:

- A. PACKAGE CONFORMS TO JEDEC TO-263 VARIATION CB EXCEPT WHERE NOTED.
  B. ALL DIMENSIONS ARE IN MILLIMETERS.
- OUT OF JEDEC STANDARD VALUE. D. DIMENSION AND TOLERANCE AS PER ASME
  - Y14.5-1994. E. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
  - F. LAND PATTERN RECOMMENDATION PER IPC. TO127P1524X465-8N.
  - G. DRAWING FILE NAME: TO263A07REV5.

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